

JIANGSU CHANGJIANG ELECTRONICS TECHNOLOGY CO., LTD

TO-252-2L Plastic-Encapsulate MOSFETS

CJU80N03 N-Channel Power MOSFET

$V_{(BR)DSS}$	R _{DS(on)} MAX	I _D
30V	6.5mΩ@10V	80A
	10mΩ@ 5V	OUA

1. GATE 2. DRAIN 3. SOURCE

DESCRIPTION

The CJU80N03 uses advanced trench technology and design to provide excellent $R_{\text{DS(ON)}}$ with low gate charge. It can be used in a wide variety of applications.

FEATURES

- High density cell design for ultra low R_{DS(ON)}
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high E_{AS}

APPLICATIONS

- Power switching application
- Hard switched and high frequency circuits

- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Uninterruptible Power Supply

MARKING



CJU80N03= Device code
Solid dot = Green molding compound device,
if none, the normal device
XXX=Date Code

EQUIVALENT CIRCUIT



MAXIMUM RATINGS (T_a=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current	I _D	80	Α
Pulsed Drain Current	I _{DM}	320	Α
Single Pulsed Avalanche Energy	E _{AS} ⁽¹⁾	306	mJ
Power Dissipation	P _D	1.25	W
Thermal Resistance from Junction to Ambient	$R_{ heta JA}$	100	°C/W
Junction Temperature	TJ	150	°C
Storage Temperature Range	T _{stg}	-55 ~+150	°C
Lead Temperature for Soldering Purposes(1/8" from case for 10s)	TL	260	℃

(1). E_{AS} condition: V_{DD} =20V,L=0.5mH, R_{G} =25 Ω , Starting T_{J} = 25 $^{\circ}C$

MOSFET ELECTRICAL CHARACTERISTICS

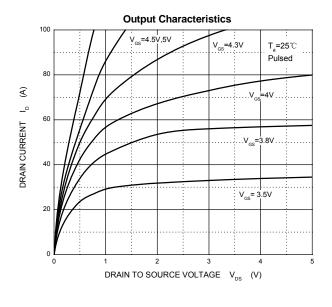
T_a =25 $^{\circ}C$ unless otherwise specified

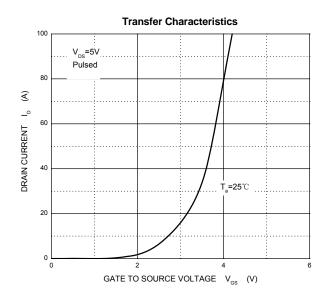
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
Off characteristics								
Drain-source breakdown voltage	V(BR) DSS	V _{GS} = 0V, I _D =250μA	30			V		
Zero gate voltage drain current	I _{DSS}	V _{DS} =30V, V _{GS} =0V			1	μΑ		
Gate-body leakage current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA		
On characteristics (note1)				•		•		
Gate-threshold voltage	VGS(th)	V _{DS} =V _{GS} , I _D =250μA	1.0	1.5	3.0	V		
Otatio ducin accusa an act annict	-	V _{GS} =10V, I _D =30A		5.1	6.5	mΩ		
Static drain-source on-sate resistance	RDS(on)	V _{GS} =5V, I _D =24A		7.1	10	mΩ		
Forward transconductance	g _{FS}	V _{DS} =5V, I _D =24A	20			S		
Dynamic characteristics (note 2)			1			•		
Input capacitance	C _{iss}			2330		pF		
Output capacitance	Coss	V _{DS} =15V,V _{GS} =0V, f =1MHz		460				
Reverse transfer capacitance	C _{rss}	1 - 11011 12		230				
Switching characteristics (note 2)				•		•		
Total gate charge	Q_g			51				
Gate-source charge	Q_{gs}	V _{DS} =10V, V _{GS} =10V, I _D =30A		14		nC		
Gate-drain charge	Q_{gd}	10-304		11				
Turn-on delay time	t _{d(on)}			20				
Turn-on rise time	tr	V _{DD} =15V,I _D =30A,		15		- ns		
Turn-off delay time	t _{d(off)}	V_{GS} =10 V , R_{G} =2.7 Ω		60				
Turn-off fall time	t f			10		1		
Drain-Source Diode Characteristics			l		ı	1		
Drain-source diode forward voltage(note1)	V _{SD}	V _{GS} =0V, I _S =24A			1.2	V		
Continuous drain-source diode forward current	Is				80	Α		
Pulsed drain-source diode forward current	I _{SM}				320	Α		

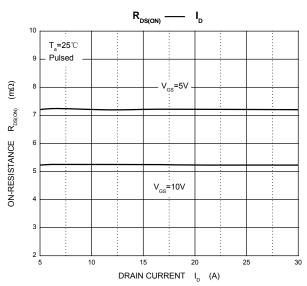
Notes:

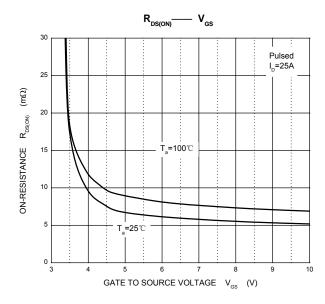
1. Pulse Test : Pulse Width≤300µs, duty cycle ≤2%.

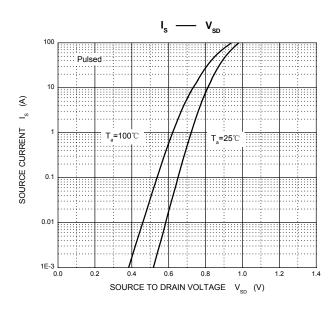
2. Guaranteed by design, not subject to production.

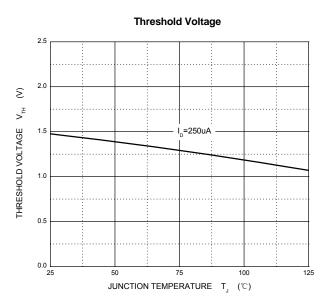




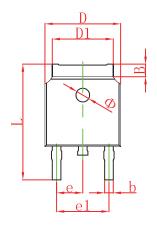


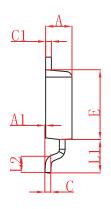


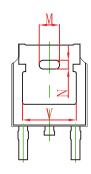




TO-252(4R)-2L Package Outline Dimensions

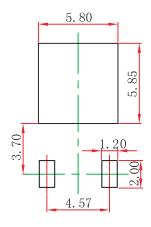






Cumbal	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.200	2.380	0.087	0.094	
A1	0.000	0.100	0.000	0.004	
В	0.800	1.400	0.031	0.055	
b	0.710	0.810	0.028	0.032	
С	0.460	0.560	0.018	0.022	
c1	0.460	0.560	0.018	0.022	
D	6.500	6.700	0.256	0.264	
D1	5.130	5.460	0.202	0.215	
Е	6.000	6.200	0.236	0.244	
е	2.286	TYP.	0.090 TYP.		
e1	4.327	4.727	0.170	0.186	
М	1.778	BREF.	0.070REF.		
N	0.762	PREF.	0.018REF.		
L	9.800	10.400	0.386	0.409	
L1	2.9F	REF.	0.114REF.		
L2	1.400	1.700	0.055	0.067	
V	4.830	REF.	0.190 REF.		
Ф	1.100	1. 300	0.043	0.051	

TO-252(4R)-2L Suggested Pad Layout



Note:

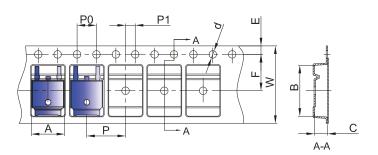
- 1. Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

NOTICE

JCET reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. JCET does not assume any liability arising out of the application or use of any product described herein.

To-252(4R)-2L Tape and Reel

TO-252 Embossed Carrier Tape

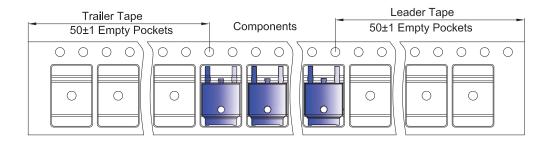


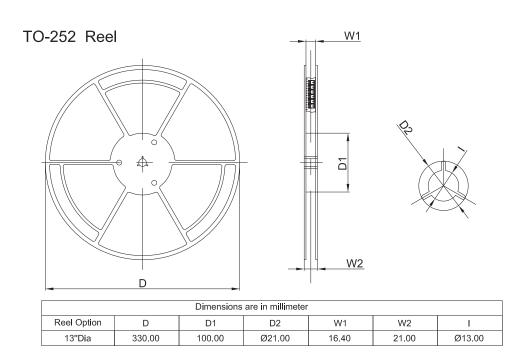
Packaging Description:

TO-252 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 25,00 units per 13" or 33.0 cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type	А	В	С	d	E	F	P0	Р	P1	W
TO-252	6.90	10.50	2.70	Ø1.55	1.75	7.50	4.00	8.00	2.00	16.00

TO-252 Tape Leader and Trailer





REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
2,500 pcs	13inch	2,500 pcs	340×336×29	25,000 pcs	353×346×365	